

**TRANSMITTAL**

Electronic Version v1.1

Stylesheet Version v1.1.0

<b>Title of Invention</b>	Wafer-Interposer Assembly Apparatus and Method						
<p>Application Number: 09/628531 Date: 2003-07-14 First Named Applicant: Mr. Jerry D. Kline Confirmation Number: 5609 Attorney Docket Number: 1384-1016</p>							
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Mr. Scott T. Griggs Registered Number: 48,331</td><td>/Scott T. Griggs/</td><td>Inventor</td></tr></tbody></table>		Submitted by:	Elec. Sign.	Sign. Capacity	Mr. Scott T. Griggs Registered Number: 48,331	/Scott T. Griggs/	Inventor
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